



# BUK663R5-30C

N-channel TrenchMOS intermediate level FET

Rev. 02 — 16 November 2010

Product data sheet

## 1. Product profile

### 1.1 General description

Intermediate level gate drive N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using advanced TrenchMOS technology. This product has been designed and qualified to the appropriate AEC Q101 standard for use in high performance automotive applications.

### 1.2 Features and benefits

- AEC Q101 compliant
- Suitable for standard and logic level gate drive sources
- Suitable for thermally demanding environments due to 175 °C rating

### 1.3 Applications

- 12 V Automotive systems
- Electric and electro-hydraulic power steering
- Motors, lamps and solenoid control
- Start-Stop micro-hybrid applications
- Transmission control
- Ultra high performance power switching

### 1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{DS}$	drain-source voltage	$T_j \geq 25\text{ °C}; T_j \leq 175\text{ °C}$	-	-	30	V
$I_D$	drain current	$V_{GS} = 10\text{ V}; T_{mb} = 25\text{ °C};$ see <a href="#">Figure 1</a>	<a href="#">[1]</a>	-	100	A
$P_{tot}$	total power dissipation	$T_{mb} = 25\text{ °C};$ see <a href="#">Figure 2</a>	-	-	158	W
<b>Static characteristics</b>						
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = 10\text{ V}; I_D = 25\text{ A};$ $T_j = 25\text{ °C};$ see <a href="#">Figure 11</a>	-	2.9	3.5	mΩ

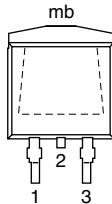
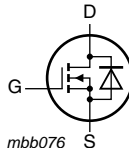
Table 1. Quick reference data ...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Avalanche ruggedness						
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$I_D = 100\text{ A}$ ; $V_{sup} \leq 30\text{ V}$ ; $R_{GS} = 50\text{ }\Omega$ ; $V_{GS} = 10\text{ V}$ ; $T_{j(init)} = 25\text{ }^\circ\text{C}$ ; unclamped	-	-	242	mJ
Dynamic characteristics						
$Q_{GD}$	gate-drain charge	$I_D = 25\text{ A}$ ; $V_{DS} = 24\text{ V}$ ; $V_{GS} = 10\text{ V}$ ; see <a href="#">Figure 13</a> ; see <a href="#">Figure 14</a>	-	20	-	nC

[1] Continuous current is limited by package.

2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		
2	D	Drain		
3	S	source		
mb	D	mounting base; connected to drain		
SOT404 (D2PAK)				

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BUK663R5-30C	D2PAK	plastic single-ended surface-mounted package (D2PAK); 3 leads (one lead cropped)	SOT404

## 4. Limiting values

**Table 4. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DS}$	drain-source voltage	$T_j \geq 25\text{ °C}$ ; $T_j \leq 175\text{ °C}$	-	30	V
$V_{GS}$	gate-source voltage	DC <a href="#">[1]</a>	-16	16	V
		Pulsed <a href="#">[2]</a>	-20	20	V
$I_D$	drain current	$T_{mb} = 25\text{ °C}$ ; $V_{GS} = 10\text{ V}$ ; see <a href="#">Figure 1</a> <a href="#">[3]</a>	-	100	A
		$T_{mb} = 100\text{ °C}$ ; $V_{GS} = 10\text{ V}$ ; see <a href="#">Figure 1</a> <a href="#">[3]</a>	-	100	A
$I_{DM}$	peak drain current	$T_{mb} = 25\text{ °C}$ ; $t_p \leq 10\text{ }\mu\text{s}$ ; pulsed; see <a href="#">Figure 3</a>	-	616	A
$P_{tot}$	total power dissipation	$T_{mb} = 25\text{ °C}$ ; see <a href="#">Figure 2</a>	-	158	W
$T_{stg}$	storage temperature		-55	175	°C
$T_j$	junction temperature		-55	175	°C
<b>Source-drain diode</b>					
$I_S$	source current	$T_{mb} = 25\text{ °C}$ <a href="#">[3]</a>	-	100	A
$I_{SM}$	peak source current	$t_p \leq 10\text{ }\mu\text{s}$ ; pulsed; $T_{mb} = 25\text{ °C}$	-	616	A
<b>Avalanche ruggedness</b>					
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	$I_D = 100\text{ A}$ ; $V_{sup} \leq 30\text{ V}$ ; $R_{GS} = 50\text{ }\Omega$ ; $V_{GS} = 10\text{ V}$ ; $T_{j(init)} = 25\text{ °C}$ ; unclamped	-	242	mJ
$E_{DS(AL)R}$	repetitive drain-source avalanche energy	<a href="#">[4]</a> <a href="#">[5]</a> <a href="#">[6]</a>	-	-	J

[1] -16V accumulated duration not to exceed 168 hrs.

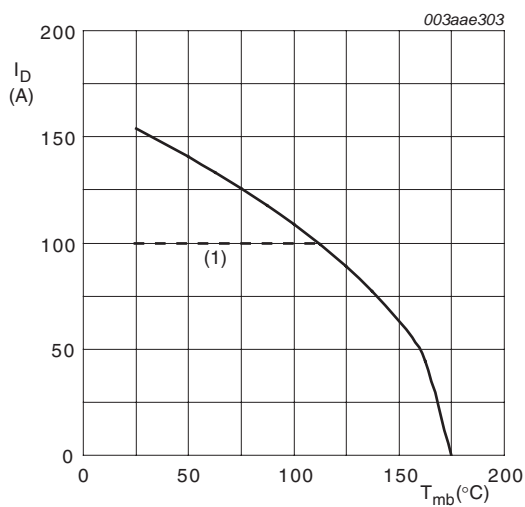
[2] Accumulated pulse duration not to exceed 5mins.

[3] Continuous current is limited by package.

[4] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

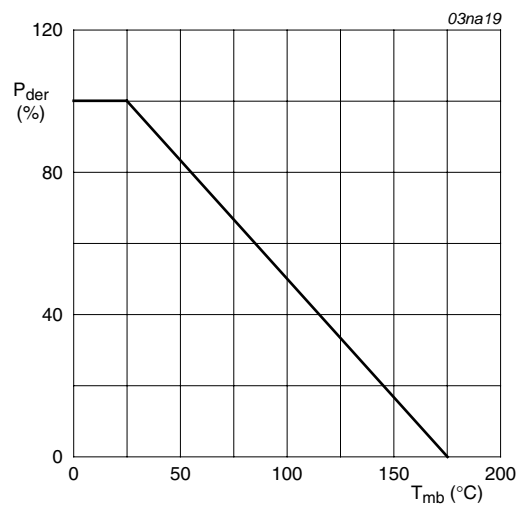
[5] Repetitive avalanche rating limited by an average junction temperature of 170 °C.

[6] Refer to application note AN10273 for further information.



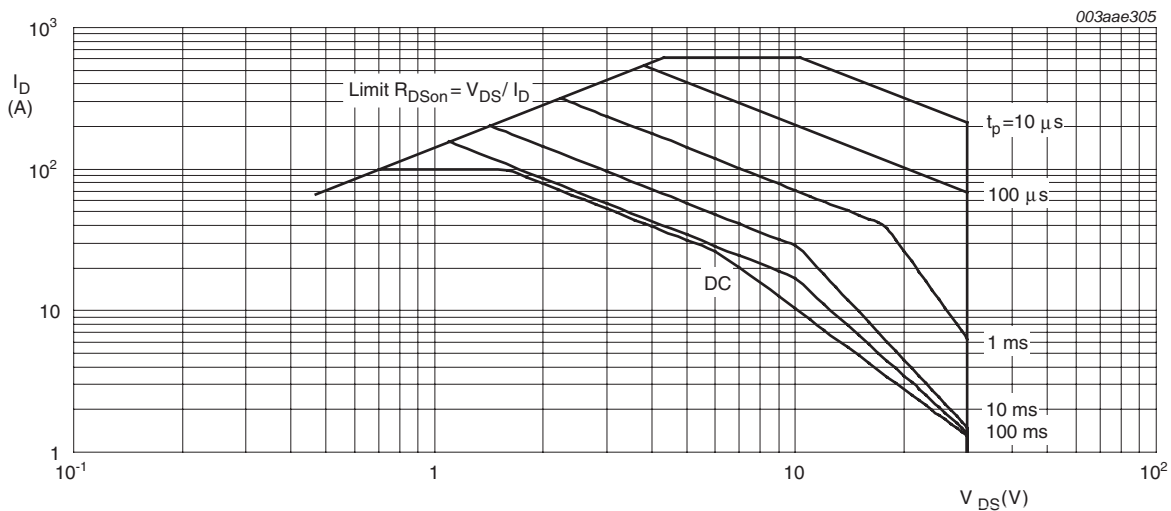
$V_{GS} \geq 10V$   
(1) Capped at 100 A due to package.

Fig 1. Continuous drain current as a function of mounting base temperature



$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100\%$$

Fig 2. Normalized total power dissipation as a function of mounting base temperature



$T_{mb} = 25^{\circ}C$ ;  $I_{DM}$  is a single pulse

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see <a href="#">Figure 4</a>	-	-	0.95	K/W

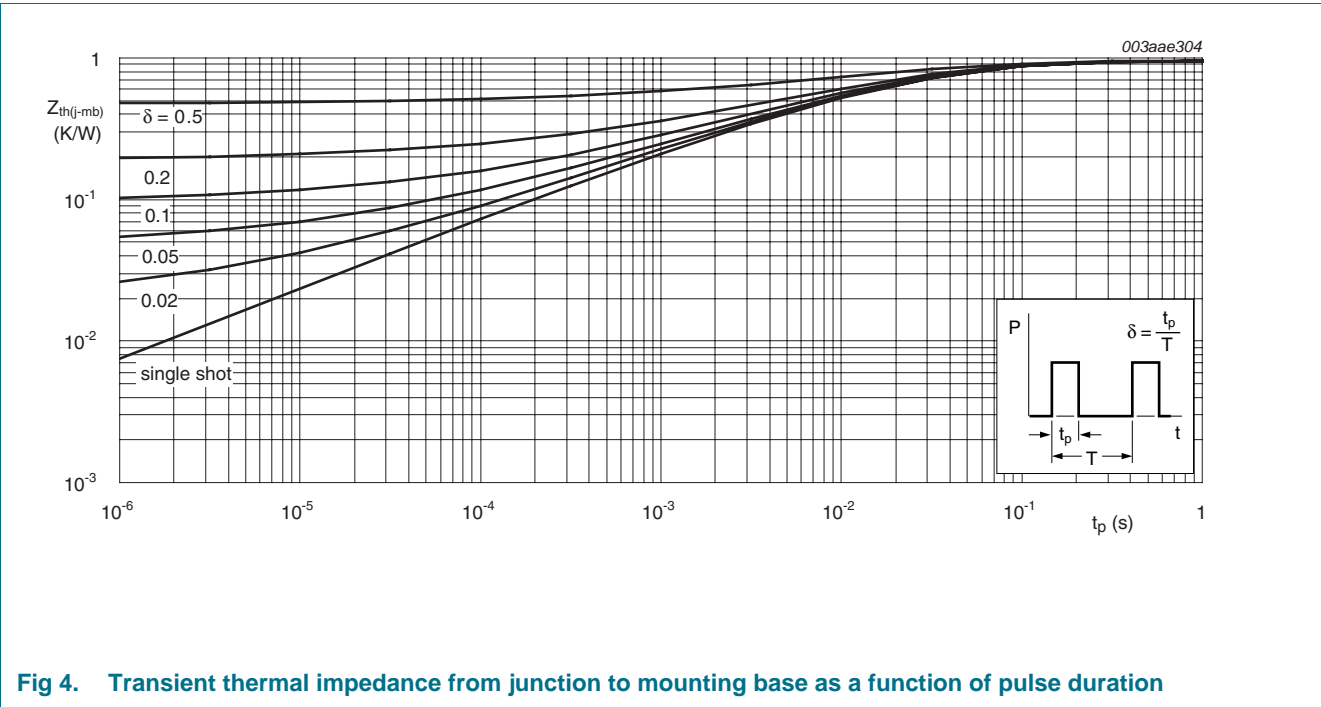


Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration

## 6. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = 250\ \mu A$ ; $V_{GS} = 0\ V$ ; $T_j = 25\ ^\circ C$	30	-	-	V
		$I_D = 250\ \mu A$ ; $V_{GS} = 0\ V$ ; $T_j = -55\ ^\circ C$	27	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 1\ mA$ ; $V_{DS} = V_{GS}$ ; $T_j = 25\ ^\circ C$ ; see <a href="#">Figure 9</a> ; see <a href="#">Figure 10</a>	1.8	2.3	2.8	V
		$I_D = 1\ mA$ ; $V_{DS} = V_{GS}$ ; $T_j = -55\ ^\circ C$ ; see <a href="#">Figure 9</a>	-	-	3.3	V
		$I_D = 1\ mA$ ; $V_{DS} = V_{GS}$ ; $T_j = 175\ ^\circ C$ ; see <a href="#">Figure 9</a>	0.8	-	-	V
$I_{DSS}$	drain leakage current	$V_{DS} = 30\ V$ ; $V_{GS} = 0\ V$ ; $T_j = 175\ ^\circ C$	-	-	500	$\mu A$
		$V_{DS} = 30\ V$ ; $V_{GS} = 0\ V$ ; $T_j = 25\ ^\circ C$	-	0.02	1	$\mu A$
$I_{GSS}$	gate leakage current	$V_{DS} = 0\ V$ ; $V_{GS} = 20\ V$ ; $T_j = 25\ ^\circ C$	-	2	100	nA
		$V_{DS} = 0\ V$ ; $V_{GS} = -20\ V$ ; $T_j = 25\ ^\circ C$	-	2	100	nA
$R_{DSon}$	drain-source on-state resistance	$V_{GS} = 10\ V$ ; $I_D = 25\ A$ ; $T_j = 25\ ^\circ C$ ; see <a href="#">Figure 11</a>	-	2.9	3.5	m $\Omega$
		$V_{GS} = 5\ V$ ; $I_D = 25\ A$ ; $T_j = 25\ ^\circ C$ ; see <a href="#">Figure 11</a>	-	4.2	5.2	m $\Omega$
		$V_{GS} = 4.5\ V$ ; $I_D = 25\ A$ ; $T_j = 25\ ^\circ C$ ; see <a href="#">Figure 11</a>	-	4.9	6.5	m $\Omega$
		$V_{GS} = 10\ V$ ; $I_D = 25\ A$ ; $T_j = 175\ ^\circ C$ ; see <a href="#">Figure 12</a> ; see <a href="#">Figure 11</a>	-	-	6.7	m $\Omega$
Dynamic characteristics						
$Q_{G(tot)}$	total gate charge	$I_D = 25\ A$ ; $V_{DS} = 24\ V$ ; $V_{GS} = 10\ V$ ; see <a href="#">Figure 13</a> ; see <a href="#">Figure 14</a>	-	78	-	nC
		$I_D = 25\ A$ ; $V_{DS} = 24\ V$ ; $V_{GS} = 5\ V$ ; see <a href="#">Figure 13</a> ; see <a href="#">Figure 14</a>	-	45	-	nC
$Q_{GS}$	gate-source charge	$I_D = 25\ A$ ; $V_{DS} = 24\ V$ ; $V_{GS} = 10\ V$ ; see <a href="#">Figure 13</a> ; see <a href="#">Figure 14</a>	-	15	-	nC
$Q_{GD}$	gate-drain charge		-	20	-	nC
$C_{iss}$	input capacitance	$V_{GS} = 0\ V$ ; $V_{DS} = 25\ V$ ; $f = 1\ MHz$ ; $T_j = 25\ ^\circ C$ ; see <a href="#">Figure 15</a>	-	3530	4707	pF
$C_{oss}$	output capacitance	$V_{GS} = 0\ V$ ; $V_{DS} = 25\ V$ ; $f = 1\ MHz$ ; $T_j = 25\ ^\circ C$ ; see <a href="#">Figure 14</a>	-	623	748	pF
$C_{rss}$	reverse transfer capacitance	$V_{GS} = 0\ V$ ; $V_{DS} = 25\ V$ ; $f = 1\ MHz$ ; $T_j = 25\ ^\circ C$	-	381	522	pF
$t_{d(on)}$	turn-on delay time	$V_{DS} = 25\ V$ ; $R_L = 1\ \Omega$ ; $V_{GS} = 10\ V$ ; $R_{G(ext)} = 10\ \Omega$	-	19	-	ns
$t_r$	rise time		-	54	-	ns
$t_{d(off)}$	turn-off delay time		-	135	-	ns
$t_f$	fall time		-	83	-	ns
$L_D$	internal drain inductance	from upper edge of drain mounting base to centre of die ; $T_j = 25\ ^\circ C$	-	3.5	-	nH
$L_S$	internal source inductance	from source lead to source bond pad ; $T_j = 25\ ^\circ C$	-	7.5	-	nH

Table 6. Characteristics ...continued

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Source-drain diode						
$V_{SD}$	source-drain voltage	$I_S = 25\text{ A}$ ; $V_{GS} = 0\text{ V}$ ; $T_J = 25\text{ }^{\circ}\text{C}$ ; see <a href="#">Figure 16</a>	-	0.8	1.2	V
$t_{rr}$	reverse recovery time	$I_S = 20\text{ A}$ ; $di_S/dt = -100\text{ A}/\mu\text{s}$ ;	-	46	-	ns
$Q_r$	recovered charge	$V_{GS} = 0\text{ V}$ ; $V_{DS} = 25\text{ V}$	-	57	-	nC

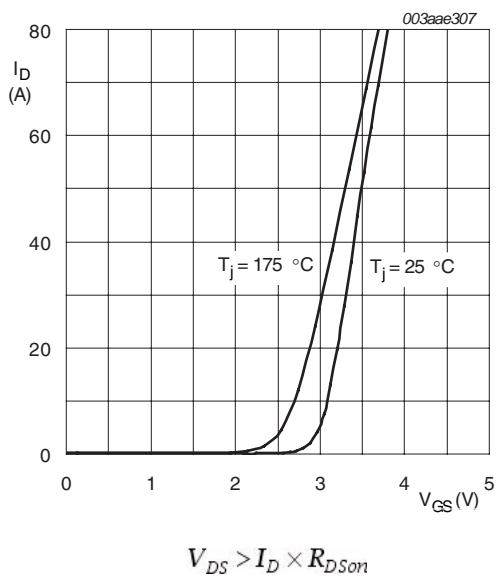


Fig 5. Transfer characteristics: drain current as a function of gate-source voltage; typical values

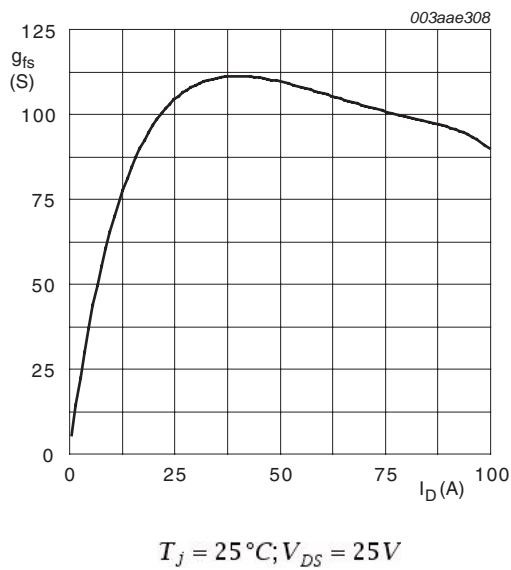


Fig 6. Forward transconductance as a function of drain current; typical values

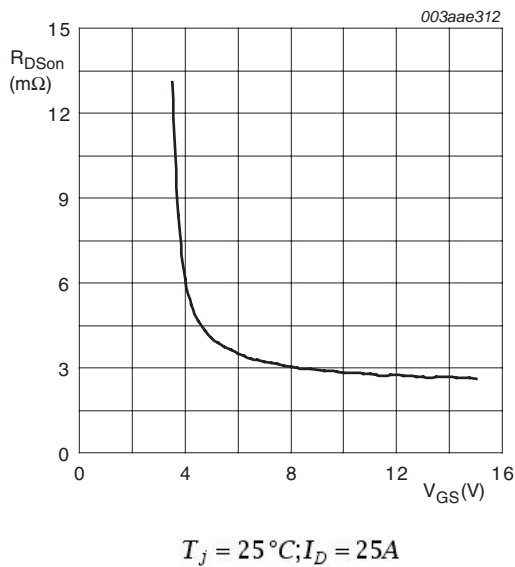


Fig 7. Drain-source on-state resistance as a function of gate-source voltage; typical values.

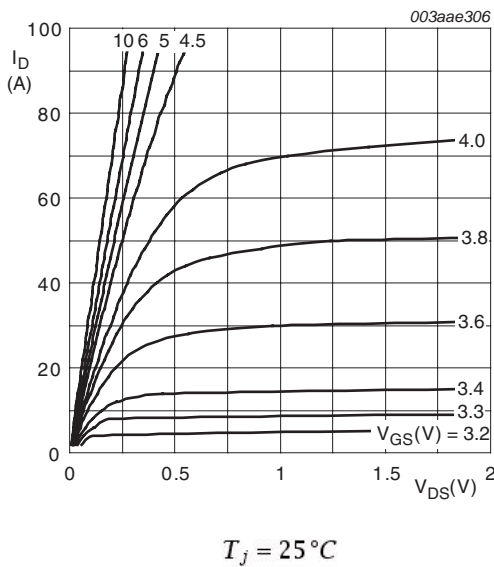
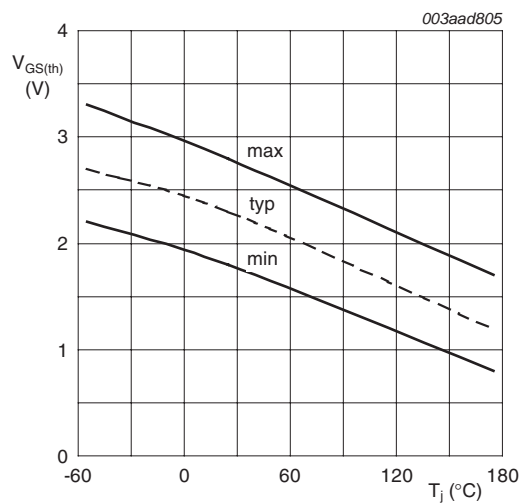
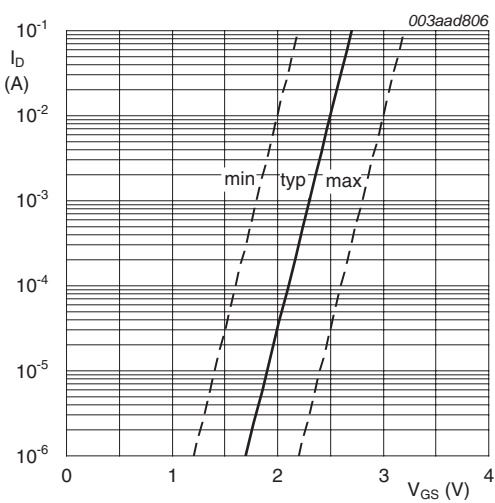


Fig 8. Output characteristics: drain current as a function of drain-source voltage; typical values



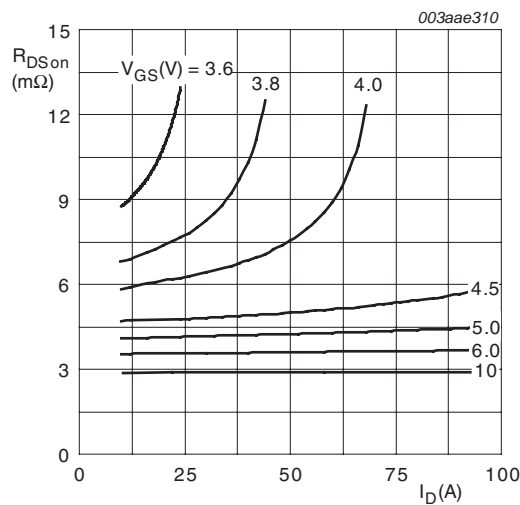
$I_D = 1\text{mA}; V_{DS} = V_{GS}$

Fig 9. Gate-source threshold voltage as a function of junction temperature



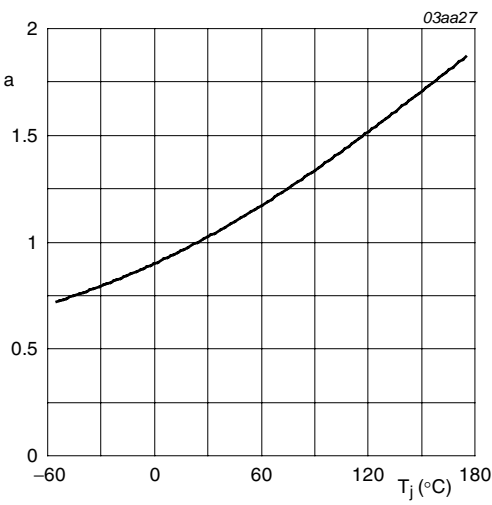
$T_j = 25\text{ }^{\circ}\text{C}; V_{DS} = 5\text{V}$

Fig 10. Sub-threshold drain current as a function of gate-source voltage



$T_j = 25\text{ }^{\circ}\text{C}$

Fig 11. Drain-source on-state resistance as a function of drain current; typical values



$a = \frac{R_{DS(on)}}{R_{DS(on)25^{\circ}\text{C}}}$

Fig 12. Normalized drain-source on-state resistance factor as a function of junction temperature



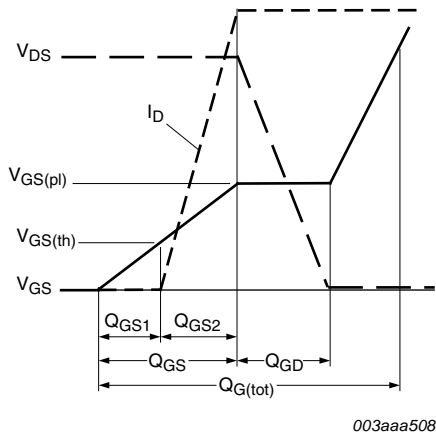
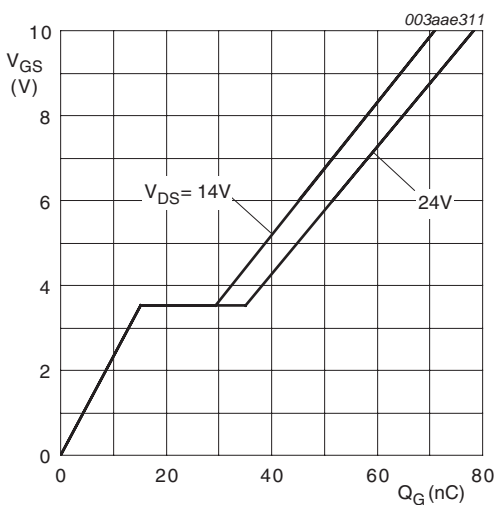
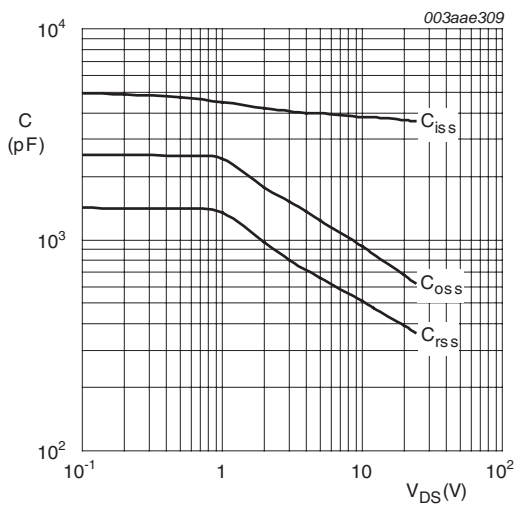


Fig 13. Gate charge waveform definitions



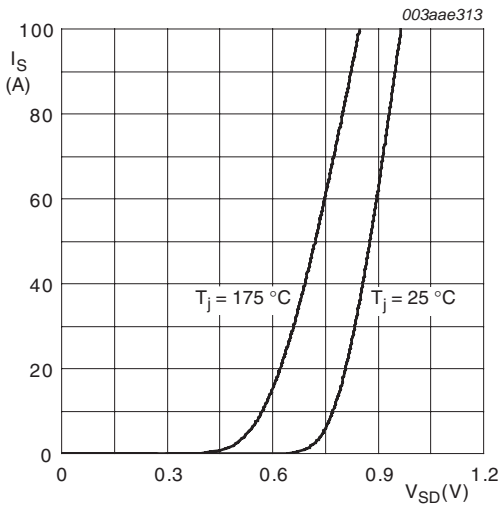
$T_j = 25\text{ }^{\circ}\text{C}; I_D = 25A$

Fig 14. Gate-source voltage as a function of gate charge; typical values



$V_{GS} = 0V; f = 1MHz$

Fig 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



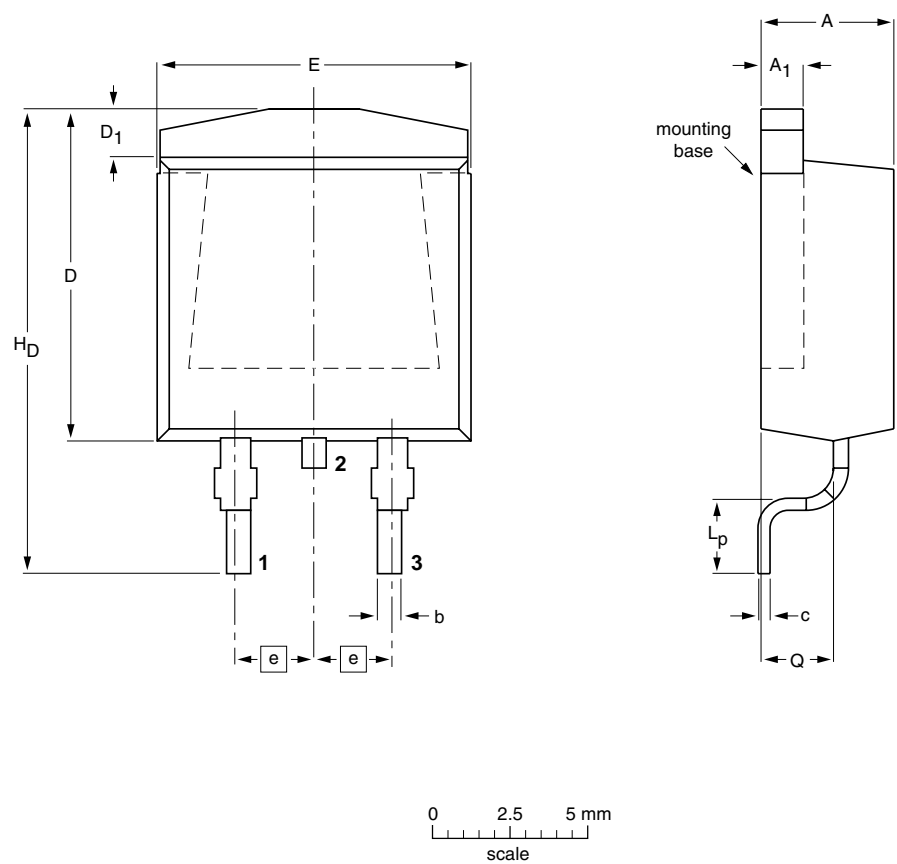
$V_{GS} = 0V$

Fig 16. Source current as a function of source-drain voltage; typical values

7. Package outline

Plastic single-ended surface-mounted package (D2PAK); 3 leads (one lead cropped)

SOT404



DIMENSIONS (mm are the original dimensions)

UNIT	A	A <sub>1</sub>	b	c	D <sub>max.</sub>	D <sub>1</sub>	E	e	L <sub>p</sub>	H <sub>D</sub>	Q
mm	4.50 4.10	1.40 1.27	0.85 0.60	0.64 0.46	11	1.60 1.20	10.30 9.70	2.54	2.90 2.10	15.80 14.80	2.60 2.20

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT404						05-02-11 06-03-16

Fig 17. Package outline SOT404 (D2PAK)

## 8. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BUK663R5-30C v.2	20101116	Product data sheet	-	BUK663R5-30C v.1
Modifications:	<ul style="list-style-type: none"><li>• Status changed from objective to product.</li><li>• Various changes to content.</li></ul>			
BUK663R5-30C v.1	20100521	Objective data sheet	-	-

## 9. Legal information

### 9.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



## JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели,  
кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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